

Product Summary (@T_A = +25°C)

Description and Applications

and telecommunication applications.

V _{RRM} (V)	I ₀ (A)	V _F (V)	Ι _R (μΑ)
1000	0.8	1.1	5

Suitable for AC to DC bridge full wave rectification for SMPS, LED

lighting, adapter, battery charger, home appliances, office equipment,

Features and Benefits

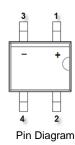
- Glass Passivated Die Construction
- Miniature Package Saves Space on PC Boards
- Low Leakage Current
- Ideal for SMT Manufacturing
- Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

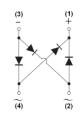
Mechanical Data

- Case: MBS
- Case Material: Molded Plastic.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish).
 Solderable per MIL-STD-202, Method 208 (3)
- Polarity: As Marked on Body
- Weight: 0.11 grams (Approximate)



Top View





Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
MB10S-13	Commercial	MBS	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

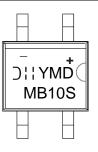
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



MB10S= Product Type Marking Code):: = Manufacturers' Code Marking YMD = Date Code Marking

- Y = Last Digit of Year (ex: 7 = 2017)
- M = See Month/Code Table Below
- D = Day 1~9 =1~9; Day 10~31= A~V

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		1,000	V
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current (Note 5)@ $T_A = +40^{\circ}C$ (Note 6)@ $T_A = +40^{\circ}C$	lo	0.5 0.8	A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	30	А
I ² t Rating for Fusing (1ms < t < 8.3ms)		3.74	A ² S

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	R _{θJA}	101	°C/W
Typical Thermal Resistance, Junction to Lead (Per Element)	R _{0JL}	42	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	1,000	—	_	V	I _R = 5μA
Forward Voltage (Per Element)	VF	_	0.93	1.1	V	$I_F = 0.8A, T_A = +25^{\circ}C$
Leakage Current (Note 7) (Per Element)	I _R	_	0.2 21	5 500	μA	V _R = 1,000V, T _A = +25°C V _R = 1,000V, T _A = +125°C
Total Capacitance (Per Element)	Ст	_	8	—	pF	$V_{R} = 4V, f = 1.0MHz$

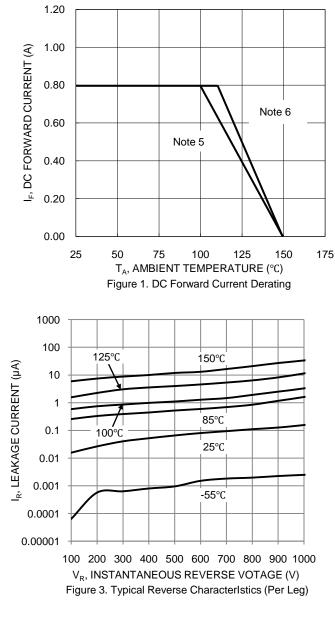
Notes:

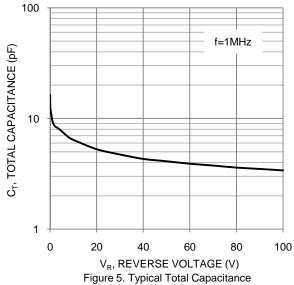
5. Device mounted on FR-4 substrate, 1"*1", 2oz, single-sided, PC boards with 0.1"*0.15" copper pad. 6. Device mounted on FR-4 substrate, 0.4"*0.5", 2oz, single-sided, PC boards with 0.2"*0.25" copper pad.

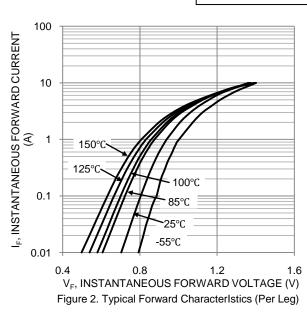
7. Short duration pulse test used to minimize self-heating effect.



MB10S







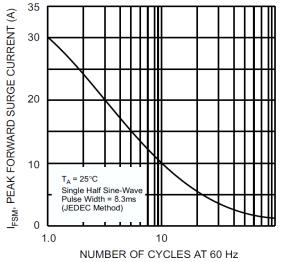
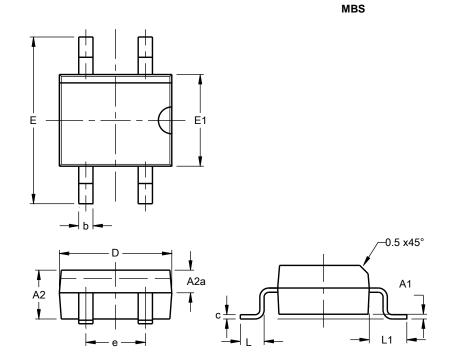


Figure 4. Maximum Peak Forward Surge Current (Per Leg)



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

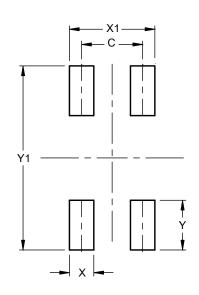


MBS								
Dim	Min Max Typ							
A1	-	0.20						
A2	2.30	2.70						
A2a	0.90	1.30						
b	0.50	0.70						
С	0.15	0.25						
D	4.50	4.95						
Е		7.00						
E1	3.60	4.10						
е	2.30	2.70						
L	0.60	1.10						
L1		1.70						
All	Dimen	sions i	in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

MBS



Dimensions	Value (in mm)
С	2.50
Х	1.00
X1	3.50
Y	2.15
Y1	7.50



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